

# FQD19N10L N-Channel QFET<sup>®</sup> MOSFET 100 V, 15.6 A, 100 mΩ

# Description

This N-Channel enhancement mode power MOSFET is produced using Fairchild Semiconductor<sup>®</sup>'s proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, audio amplifier, DC motor control, and variable switching power applications.

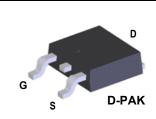
## Features

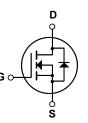
• 15.6 A, 100 V,  $R_{DS(on)}$  = 100 m $\Omega$  (Max.) @ V<sub>GS</sub> = 10 V

FQD19N10L N-Channel QFET<sup>®</sup> MOSFET

March 2013

- Low Gate Charge (Typ. 14 nC)
- Low Crss (Typ. 35 pF)
- 100% Avalanche Tested





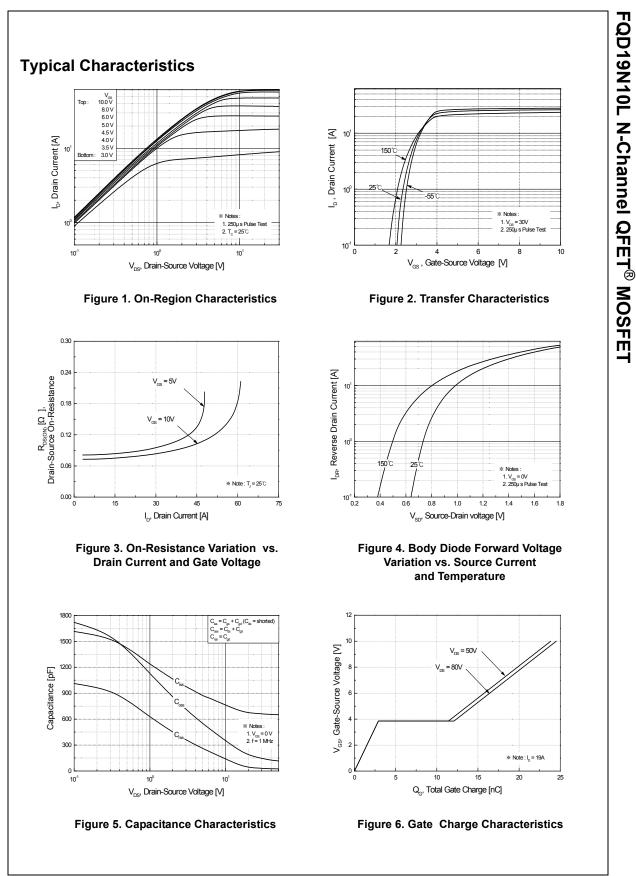
# Absolute Maximum Ratings T<sub>c</sub> = 25°C unless otherwise noted

| Symbol                            | Parameter   |                                   | FQD19N10L   | Unit        |      |
|-----------------------------------|---|-----------------------------------|-------------|-------------|------|
| V <sub>DSS</sub>                  | Drain-Source V  | rain-Source Voltage               |             | 100         | V    |
| I <sub>D</sub>                    | Drain Current - Continuous (T <sub>C</sub> = 25°C)                            |                                   | °C)         | 15.6        | А    |
|                                   |   | - Continuous (T <sub>C</sub> = 10 | O°C)        | 9.8         | А    |
| I <sub>DM</sub>                   | Drain Current   | - Pulsed                          | (Note 1)    | 62.4        | A    |
| V <sub>GSS</sub>                  | Gate-Source Voltage   |                                   |             | ± 20        | V    |
| E <sub>AS</sub>                   | Single Pulsed Avalanche Energy  |                                   | (Note 2)    | 220         | mJ   |
| I <sub>AR</sub>                   | Avalanche Current   |                                   | (Note 1)    | 15.6        | А    |
| E <sub>AR</sub>                   | Repetitive Avala  | anche Energy                      | (Note 1)    | 5.0         | mJ   |
| dv/dt                             | Peak Diode Re   | covery dv/dt                      | (Note 3)    | 6.0         | V/ns |
| P <sub>D</sub>                    | Power Dissipation (T <sub>A</sub> = 25°C) *                                   |                                   |             | 2.5         | W    |
|                                   | Power Dissipation (T <sub>C</sub> = 25°C)                                     |                                   |             | 50          | W    |
|                                   | - Derate above 25°C   |                                   |             | 0.4         | W/°C |
| T <sub>J</sub> , T <sub>STG</sub> | Operating and Storage Temperature Range                                       |                                   | nge         | -55 to +150 | °C   |
| TL                                | Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds |                                   | g purposes, | 300         | °C   |

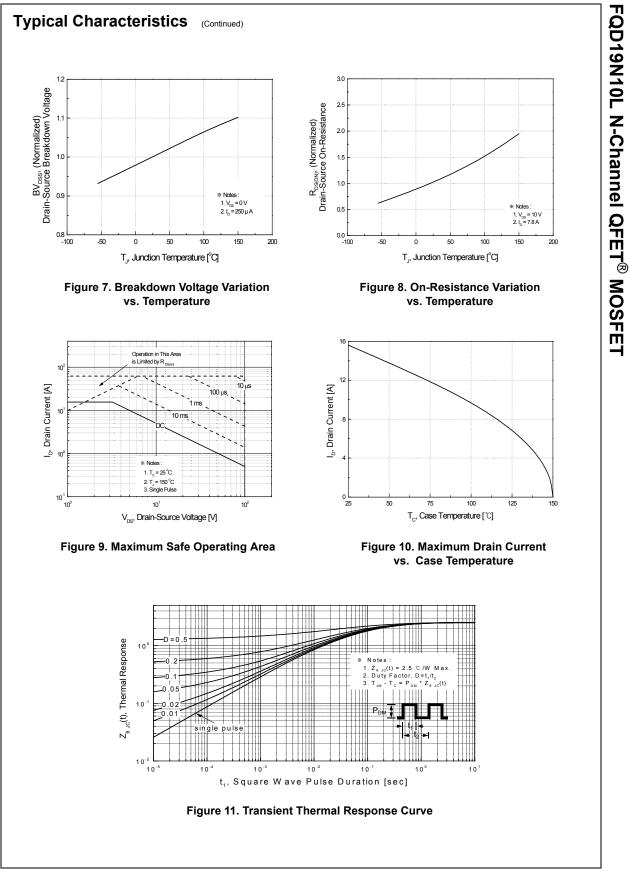
# **Thermal Characteristics**

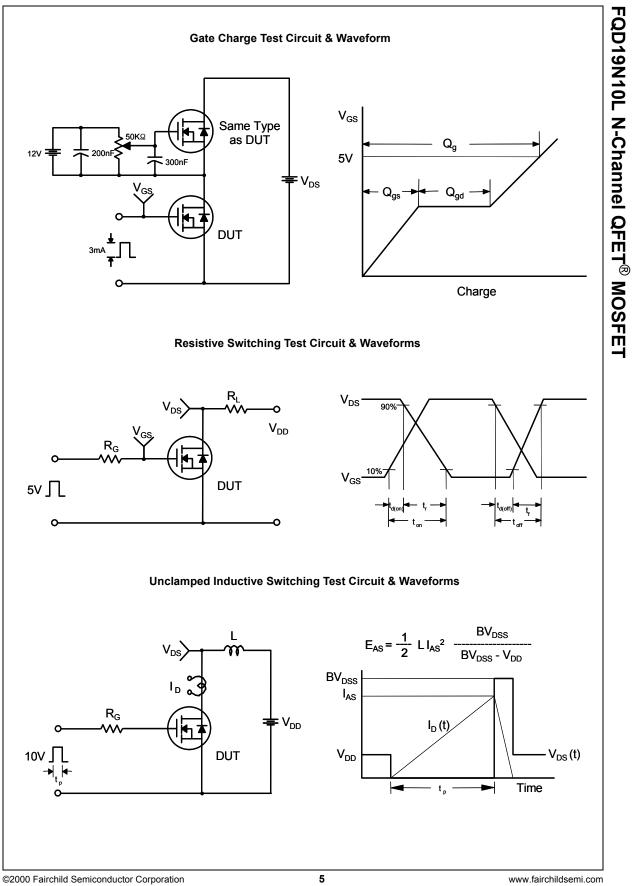
| Symbol                | Parameter                                     | FQD19N10L | Unit |
|-----------------------|---|-----------|------|
| $R_{	extsf{	heta}JC}$ | Thermal Resistance, Junction-to-Case, Max.    | 2.5       |      |
| $R_{\thetaJA}$        | Thermal Resistance, Junction-to-Ambient *     | 50        | °C/W |
| $R_{\theta JA}$       | Thermal Resistance, Junction-to-Ambient, Max. | 110       |      |

| BV <sub>DSS</sub><br>ΔBV <sub>DSS</sub><br>ΔΔT <sub>J</sub><br>DSS  | racteristics<br>Drain-Source Breakdown Voltage   |  |              |                                      |  | Unit                       |
|---|--|--|--------------|--------------------------------------|--|----------------------------|
| BV <sub>DSS</sub><br>ΔBV <sub>DSS</sub><br>ΔΔT <sub>J</sub><br>DSS  |  |  |              |                                      |  |                            |
| I <sub>DSS</sub>  | Dialii-Source Breakuowii Vollage   | V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250 μA   | 100          |                                      |  | V                          |
|   | Breakdown Voltage Temperature<br>Coefficient   | $I_D$ = 250 µA, Referenced to 25°C   |              | 0.09                                 |  | V/°C                       |
| المعمد  | Zara Cata Valtaga Drain Current  | V <sub>DS</sub> = 100 V, V <sub>GS</sub> = 0 V   |              |                                      | 1  | μA                         |
| lagar   | Zero Gate Voltage Drain Current  | V <sub>DS</sub> = 80 V, T <sub>C</sub> = 125°C   |              |                                      | 10   | μA                         |
| I <sub>GSSF</sub>   | Gate-Body Leakage Current, Forward   | V <sub>GS</sub> = 20 V, V <sub>DS</sub> = 0 V  |              |                                      | 100  | nA                         |
| I <sub>GSSR</sub>   | Gate-Body Leakage Current, Reverse   | $V_{GS}$ = -20 V, $V_{DS}$ = 0 V   |              |                                      | -100   | nA                         |
| On Cha  | racteristics   |  |              |                                      |  |                            |
| V <sub>GS(th)</sub>   | Gate Threshold Voltage   | V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250 μA  | 1.0          |                                      | 2.0  | V                          |
| R <sub>DS(on)</sub>   | Static Drain-Source  | V <sub>GS</sub> = 10 V, I <sub>D</sub> = 7.8 A   |              | 0.074                                | 0.10   |                            |
| DO(011)   | On-Resistance  | V <sub>GS</sub> = 5 V, I <sub>D</sub> = 7.8 A  |              | 0.082                                | 0.11   | Ω                          |
| 9 <sub>FS</sub>   | Forward Transconductance   | V <sub>DS</sub> = 30 V, I <sub>D</sub> = 7.8 A   |              | 14                                   |  | S                          |
| Dunomi  | a Characteriatica  |  |              |                                      |  |                            |
| C <sub>iss</sub>  | ic Characteristics   | acitance $V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V},$ apacitancef = 1.0 MHz  |              | 670                                  | 870  | pF                         |
| C <sub>oss</sub>  | Output Capacitance   |  |              | 160                                  | 210  | pF                         |
| C <sub>rss</sub>  | Reverse Transfer Capacitance   |  |              | 35                                   | 45   | pF                         |
| Switchi   |  |  |              |                                      |  |                            |
| Switchi   |  |  |              |                                      |  |                            |
| t <sub>d(on)</sub>  | Turn-On Delay Time   | V <sub>DD</sub> = 50 V, I <sub>D</sub> = 19 A,   |              | 14                                   | 38   | ns                         |
| t <sub>d(on)</sub><br>t <sub>r</sub>  | Turn-On Delay Time<br>Turn-On Rise Time  | $V_{DD} = 50 \text{ V}, \text{ I}_{D} = 19 \text{ A},$<br>R <sub>G</sub> = 25 $\Omega$   |              | 410                                  | 830  | ns                         |
| t <sub>d(on)</sub><br>t <sub>r</sub><br>t <sub>d(off)</sub>   | Turn-On Delay Time<br>Turn-On Rise Time<br>Turn-Off Delay Time   |  |              | 410<br>20                            | 830<br>50                                      | ns<br>ns                   |
| t <sub>d(on)</sub><br>t <sub>r</sub><br>t <sub>d(off)</sub><br>t <sub>f</sub>   | Turn-On Delay Time<br>Turn-On Rise Time<br>Turn-Off Delay Time<br>Turn-Off Fall Time   | R <sub>G</sub> = 25 Ω  |              | 410<br>20<br>140                     | 830<br>50<br>290                               | ns<br>ns<br>ns             |
| t <sub>d(on)</sub><br>t <sub>r</sub><br>t <sub>d(off)</sub><br>t <sub>f</sub><br>Q <sub>g</sub>   | Turn-On Delay Time         Turn-On Rise Time         Turn-Off Delay Time         Turn-Off Fall Time         Total Gate Charge  | $R_{G} = 25 \Omega$<br>V <sub>DS</sub> = 80 V, I <sub>D</sub> = 19 A,  |              | 410<br>20<br>140<br>14               | 830<br>50<br>290<br>18                         | ns<br>ns<br>ns<br>nC       |
| t <sub>d(on)</sub><br>t <sub>r</sub><br>t <sub>d(off)</sub><br>t <sub>f</sub><br>Q <sub>g</sub><br>Q <sub>gs</sub>                                      | Turn-On Delay Time         Turn-On Rise Time         Turn-Off Delay Time         Turn-Off Fall Time         Total Gate Charge         Gate-Source Charge   | $R_G = 25 \Omega$<br>V <sub>DS</sub> = 80 V, I <sub>D</sub> = 19 A,<br>V <sub>GS</sub> = 5 V   | <br><br>     | 410<br>20<br>140<br>14<br>2.9        | 830<br>50<br>290<br>18<br>                     | ns<br>ns<br>nC<br>nC       |
| Switchi<br>$t_{d(on)}$<br>$t_r$<br>$t_{d(off)}$<br>$t_f$<br>$Q_g$<br>$Q_{gs}$<br>$Q_{gd}$<br>Drain-S  | Turn-On Delay Time         Turn-On Rise Time         Turn-Off Delay Time         Turn-Off Fall Time         Total Gate Charge         Gate-Source Charge         Gate-Drain Charge   | $R_{G}$ = 25 Ω<br>$V_{DS}$ = 80 V, I <sub>D</sub> = 19 A,<br>$V_{GS}$ = 5 V (Note 4)   |              | 410<br>20<br>140<br>14               | 830<br>50<br>290<br>18                         | ns<br>ns<br>ns<br>nC       |
| t <sub>d(on)</sub><br>t <sub>r</sub><br>t <sub>d(off)</sub><br>t <sub>f</sub><br>Q <sub>g</sub><br>Q <sub>gs</sub><br>Q <sub>gd</sub>                   | Turn-On Delay Time         Turn-On Rise Time         Turn-Off Delay Time         Turn-Off Fall Time         Total Gate Charge         Gate-Source Charge   | $R_{G} = 25 \Omega$ $V_{DS} = 80 V, I_{D} = 19 A,$ $V_{GS} = 5 V$ (Note 4)   | <br><br>     | 410<br>20<br>140<br>14<br>2.9        | 830<br>50<br>290<br>18<br>                     | ns<br>ns<br>nC<br>nC       |
| t <sub>d(on)</sub><br>t <sub>r</sub><br>t <sub>d(off)</sub><br>t <sub>f</sub><br>Q <sub>g</sub><br>Q <sub>gs</sub><br>Q <sub>gd</sub><br><b>Drain-S</b> | Turn-On Delay Time<br>Turn-On Rise Time<br>Turn-Off Delay Time<br>Turn-Off Fall Time<br>Total Gate Charge<br>Gate-Source Charge<br>Gate-Drain Charge<br>ource Diode Characteristics an   | $R_{G} = 25 \Omega$ $V_{DS} = 80 V, I_{D} = 19 A,$ $V_{GS} = 5 V$ (Note 4)<br><b>nd Maximum Ratings</b><br>de Forward Current                    | <br><br>     | 410<br>20<br>140<br>14<br>2.9<br>9.2 | 830<br>50<br>290<br>18<br><br>                 | ns<br>ns<br>nC<br>nC<br>nC |
| t <sub>d(on)</sub><br>t <sub>r</sub><br>t <sub>d(off)</sub><br>t <sub>f</sub><br>Q <sub>g</sub><br>Q <sub>gs</sub><br>Q <sub>gd</sub><br><b>Drain-S</b> | Turn-On Delay Time<br>Turn-On Rise Time<br>Turn-Off Delay Time<br>Turn-Off Fall Time<br>Total Gate Charge<br>Gate-Source Charge<br>Gate-Drain Charge<br>ource Diode Characteristics an<br>Maximum Continuous Drain-Source Dio            | $R_{G} = 25 \Omega$ $V_{DS} = 80 V, I_{D} = 19 A,$ $V_{GS} = 5 V$ (Note 4)<br><b>nd Maximum Ratings</b><br>de Forward Current<br>Forward Current | <br><br><br> | 410<br>20<br>140<br>14<br>2.9<br>9.2 | 830<br>50<br>290<br>18<br><br><br>15.6         | ns<br>ns<br>nC<br>nC<br>nC |
| t <sub>d(on)</sub><br>t <sub>r</sub><br>t <sub>d(off)</sub><br>t <sub>f</sub><br>Q <sub>gs</sub><br>Q <sub>gd</sub><br><b>Drain-S</b><br>I <sub>S</sub> | Turn-On Delay Time<br>Turn-On Rise Time<br>Turn-Off Delay Time<br>Turn-Off Fall Time<br>Total Gate Charge<br>Gate-Source Charge<br>Gate-Drain Charge<br><b>ource Diode Characteristics al</b><br>Maximum Continuous Drain-Source Diode F | $R_{G} = 25 \Omega$ $V_{DS} = 80 V, I_{D} = 19 A,$ $V_{GS} = 5 V$ (Note 4)<br><b>nd Maximum Ratings</b><br>de Forward Current<br>Forward Current | <br><br><br> | 410<br>20<br>140<br>14<br>2.9<br>9.2 | 830<br>50<br>290<br>18<br><br><br>15.6<br>62.4 | ns<br>ns<br>nC<br>nC<br>nC |

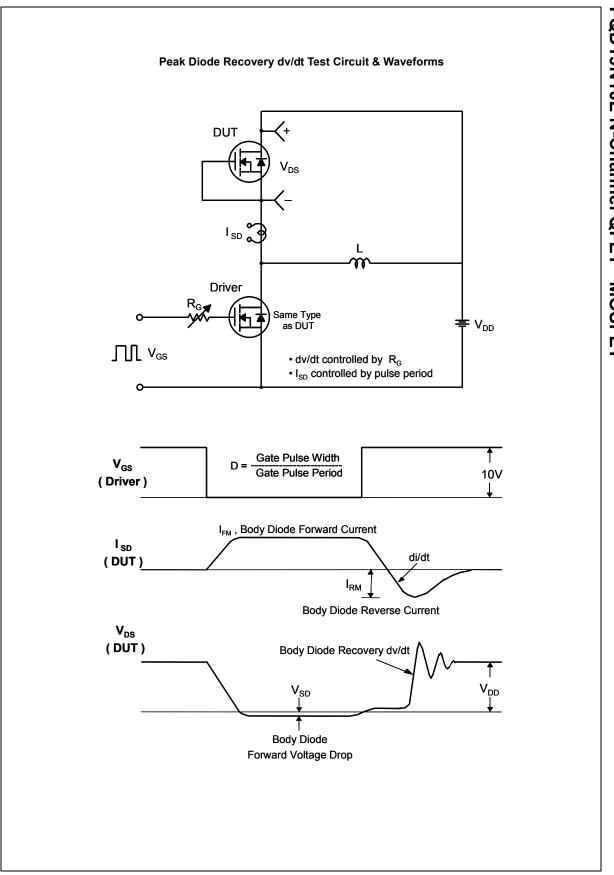


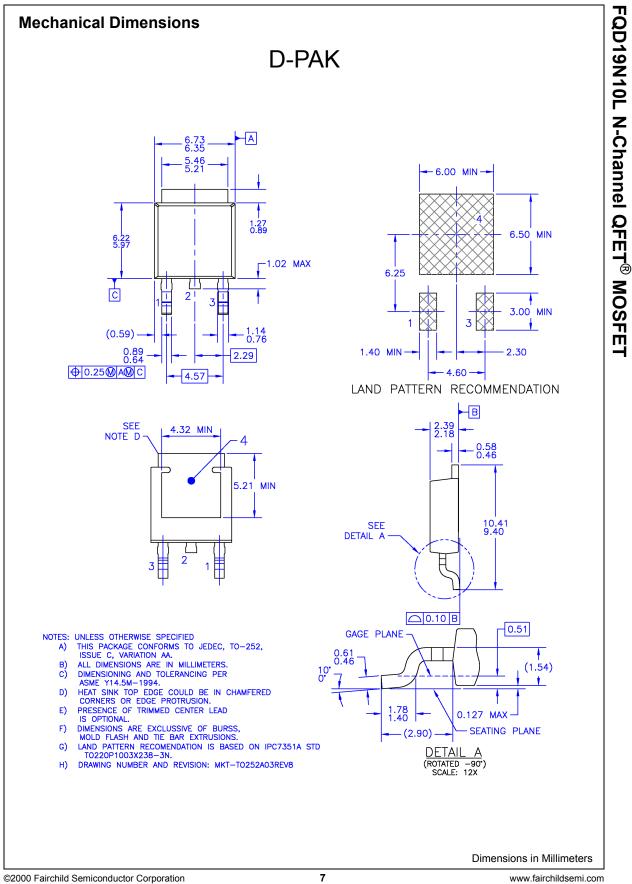
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